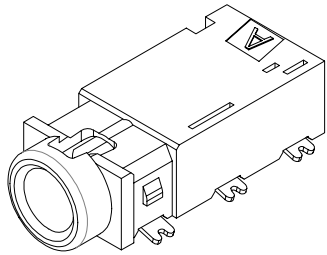
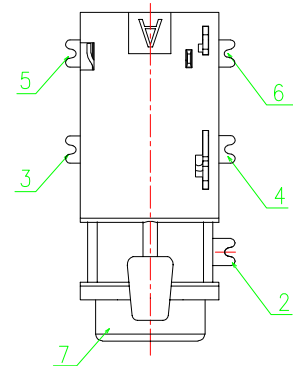
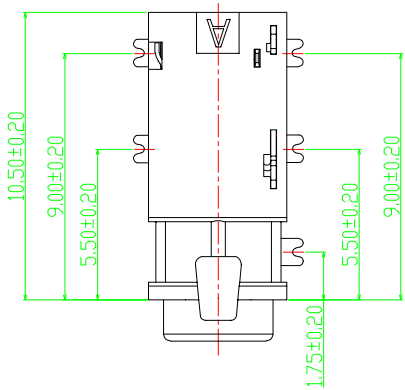
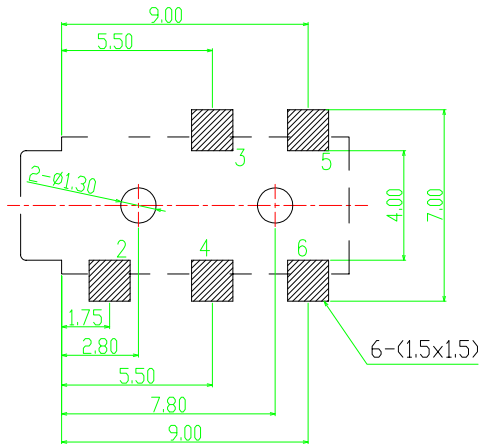


REV.	ECN. NO.	DESCRIPTION	ENG	DATE
A		INITIAL	Lucky	11 /14 /17'

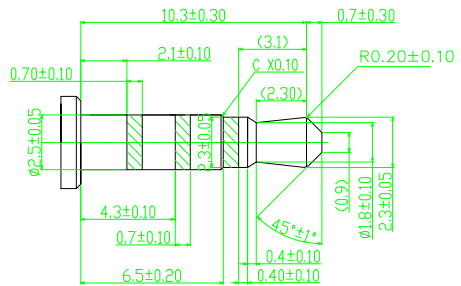
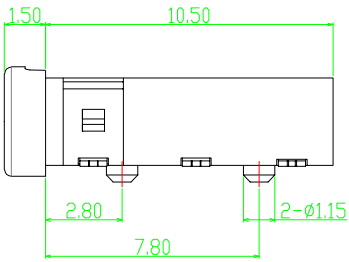
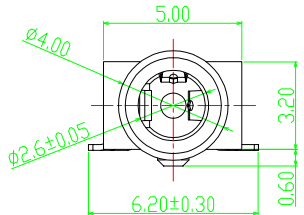
- 1. CONTACT CURRENT RATING: 1A.
- 2. CONTACT RESISTANCE: 100 mΩ MAX.;
- 3. INSULATION RESISTANCE: 1000MΩ MIN.;
- 4. DIELECTRIC WITHSTANDING: 500V AC MIN.;
- 5. DURABILITY: 5,000 CYCLES MIN.;
- 6. CONNECTOR MATING FORCES: 29.4N (3.00Kgf) MAX.;
- 7. CONNECTOR UNMATING FORCES: 2.94N(0.30Kgf) MIN.;



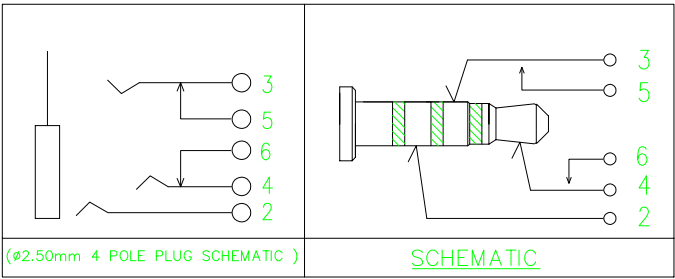
3D VIEW



P.C.B. LAYOUT TOP VIEW



(Ø2.50mm 4 POLE PLUG DETAIL DRAWING)



ITEM	NAME	Q'TY	DESCRIPTION	NOTE
6	HOUSING	1	HIGH TEMPERATURE;COLOR BLACK	
5	TERMINAL 5#	1	PHOSPHOR BRONZE; NICKEL : UNDER PLATING OVERALL;GOLD FLASH(0.8U"MIN) PLATING ON SOLDER AREA	
4	TERMINAL 4#	1	STAINLESS STEEL; NICKEL : UNDER PLATING OVERALL;GOLD FLASH(0.8U"MIN) PLATING ON SOLDER AREA ;GOLD FLASH(0.4U"MIN) PLATING ON CONTACT AREA	
3	TERMINAL 3#	1	STAINLESS STEEL; NICKEL : UNDER PLATING OVERALL;GOLD FLASH(0.8U"MIN) PLATING ON SOLDER AREA ;GOLD FLASH(0.4U"MIN) PLATING ON CONTACT AREA	
2	TERMINAL 2#	1	PHOSPHOR BRONZE; NICKEL : UNDER PLATING OVERALL;GOLD FLASH(0.8U"MIN) PLATING ON SOLDER AREA ;GOLD FLASH(0.4U"MIN) PLATING ON CONTACT AREA	
1	TERMINAL 1#	1	PHOSPHOR BRONZE; NICKEL : UNDER PLATING OVERALL;GOLD FLASH(0.8U"MIN) PLATING ON SOLDER AREA ;GOLD FLASH(0.4U"MIN) PLATING ON CONTACT AREA	

MEASURE POINT:
QUADRANT POINT
TANGENCY POINT
INTERSECTION POINT

QP
TP
IP

XGB 东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.

DESIGN: Lucky
CHECKED
APPROVED
PART NO. PJ25A001-F05J1BR-A
DRAWING NO.

DATE 2018/01/31
DATE
DATE
REV.: A
SCALE: 1:1
UNIT: mm
SIZE: A4
SHEET: 1/1

TITLE:
Ø2.5mm PHONE JACK H=3.2 mm
SMT TYPE CONNECTOR